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OF L		\Box	110

CUSTOMER . MIE

SAMPLE CODE . SE12864WRF-004HC1Q

MASS PRODUCTION CODE . PE12864WRF-004HC1Q

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 002

DRAWING NO. (Ver.) · JLMD- PE12864WRF-004HC1Q_001

PACKAGING NO. (Ver.) : JPKG- PE12864WRF-004HC1Q_001

Customer Approved

Date:

POWERTIP 2013.08.23 JS RD APPROVED

Approved	Checked	Designer
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Ryan	Lori	Bruce

☐ Preliminary specification for design input

■ Specification for sample approval

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History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
01/18/2006	0	0	New Sample	-	劉傳德
07/29/2013	01	001	Change Stiffener	-	李誠
08/23/2013	01	002	Update Specification	-	李誠

Total: 30Page



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Note: For detailed information please refer to IC data sheet: Sitronix -ST7565S-G



1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	128 * 64 Dots
LCD Type	FSTN White , Positive , Transflective,Extended Temp
Driver Condition	LCD Module : 1/65 Duty , 1/9 Bias
Viewing Direction	6 O'clock
Backlight	White LED B/L
Weight	25g
Interface	8-bit parallel data input and serial data input
Other(controller/driver IC)	ST7565S-G
	THIS PRODUCT CONFORMS THE ROHS OF PTC
ROHS	Detail information please refer web site :
	http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	80.0 (L) * 54.0 (w) *10.3max (H)	mm
Viewing Area	70.7 (L) *38.8 (w)	mm
Active Area	66.52 (L) * 33.24 (w)	mm
Dot Size	0.48 (L) * 0.48 (w)	mm
Dot Pitch	0.52 (L) * 0.52(w)	mm

Note: For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Power Supply Voltage	V_{dd}	_	-0.3	5.0	V
LCD Driver Supply Voltage	V_{LCD}	_	-18	0.3	V
Input Voltage	V _{IN}	_	-0.3	VDD+0.3	V
Operating Temperature	T _{OP}	_	-20	70	$^{\circ}\mathbb{C}$
Storage Temperature	T _{ST}	_	-30	80	$^{\circ}\mathbb{C}$
Storage Humidity	H _D	Ta<60 ℃	-	90	%RH

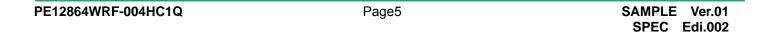
1.4 DC Electrical Characteristics

Ta = 25°℃

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Logic Supply Voltage	V_{dd}	-	3.0	3.3	3.6	V
"H" Input Voltage	V _{IH}	-	0.8VDD	_	VDD	V
"L" Input Voltage	V _{IL}	-	VSS	-	0.2VDD	V
"H" Output Voltage	V _{OH}	-	0.8VDD	ı	VDD	V
"L" Output Voltage	V_{OL}		VSS	ı	0.2VDD	V
Supply Current	I _{dd} *1	V _{DD} = 3.3V	-	0.2	1.0	mA
LCM Driver Voltage	V _{OP} *2	25 ℃	9.4	9.7	10	V

NOTE: *1 The Maximum current display

*2 The VOP test point is VDD-V5





1.5 Optical Characteristics

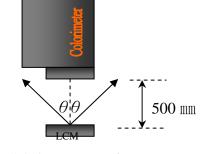
LCD Panel:1/65Duty,1/9Bias,V_{LCD} =9.7V,Ta =25°C

Item		Symbol	Conditions	Min.	Тур.	Max.	Unit	Reference
Response Time	Rise	tr	_	-	150	300	ms	Notes 2
response fille	Fall	tf	_	-	150	300	ПЗ	140163 2
	Тор	Θ+		1	40	-		
Viewing angle	Bottom	Θ-	C <u>></u> 2.0,	1	40	-	Deg.	Notes 1
range	Left	ΘL	0 <u>~</u> 2.0,	-	45	-	Deg.	INOTES I
	Right	ΘR		-	45	-		
Contrast Ratio (With LCD, Without B/L)		CR	θ = 0°	-	5	-		Note 3
CIE Color Coor	dinate	Х		0.27	0.32	0.37		Notes 4
(With LCD)		Y	IF=30 mA	0.30	0.35	0.40		Notes 4
Average Brightness (with LCD) *1		IV	11 -30 IIIA	50	70	-	cd/m ²	
Uniformity '	` 2	∆B		70	-	-	%	Notes 4

Note 4

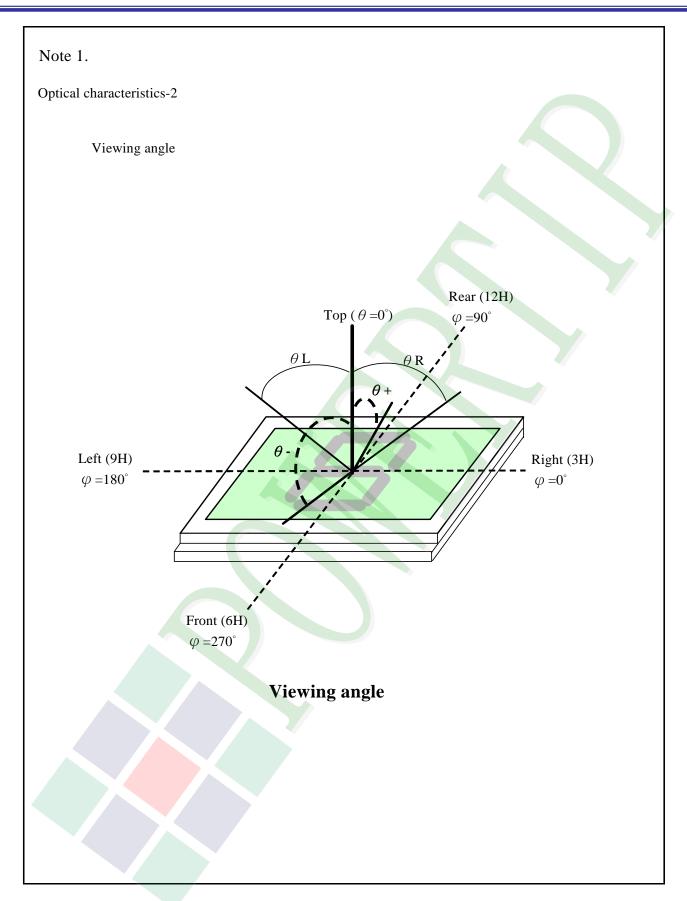
- 1 : △B=B(min) / B(max) * 100%
- 2 : Measurement Condition for Optical Characteristics:
 - a : Environment: 25°C±5°C / 60±20%R.H → no wind → dark room below 10 Lux at typical lamp current and typical operating frequency.
 - b : Measurement Distance: $500 \pm 50 \text{ mm}$, $(\theta = 0^{\circ})$
 - c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation.
 - d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%



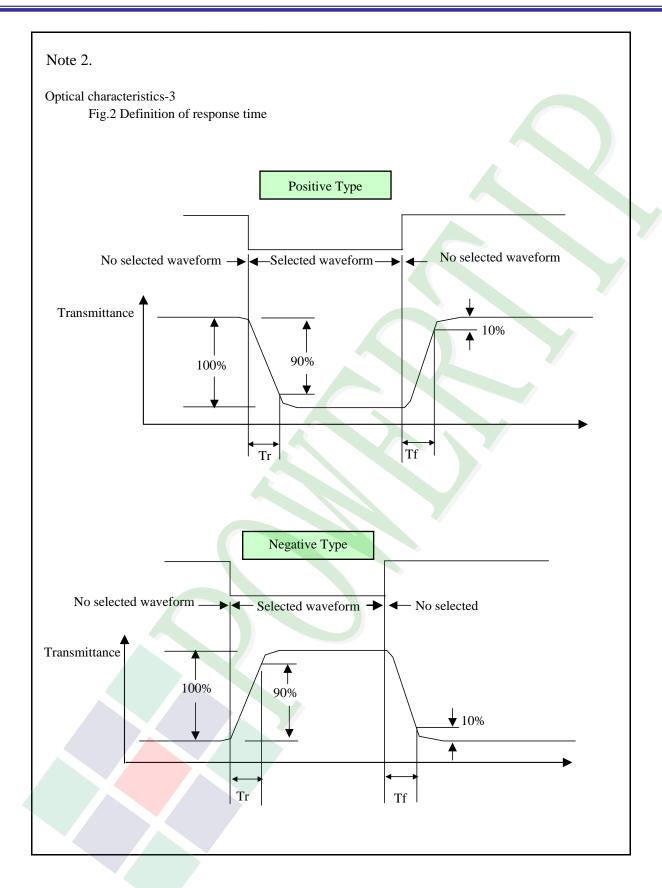


Colorimeter=BM-7 fast











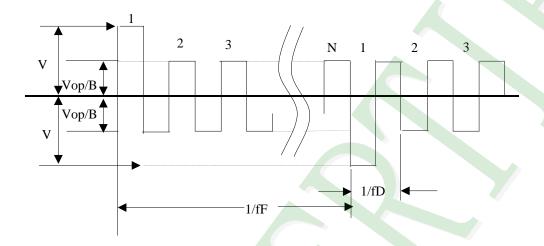
Electrical characteristics-2

[™] 2 Drive waveform

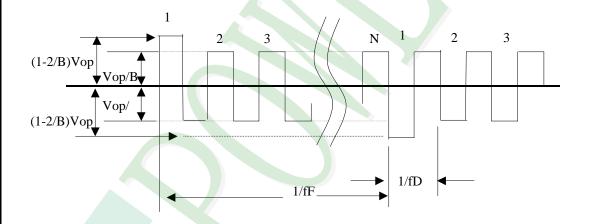
Vop: Drive voltage fF: Frame frequency 1/B: Bias fD: Drive frequency

N: Duty

(1) Selected waveform



(2) Non- Selected wave form

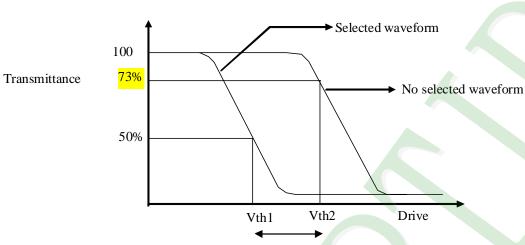


Note:

Frame frequency is defined as follows: Common side supply voltage peak - to - peak /2 = 1 period



Note 3.: Definition of Vth



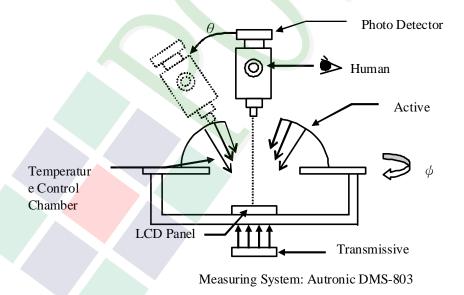
Active voltage range

	Vth1	Vth2
View direction	10 °	40 °
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

※1 Contrast ratio

= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System





1.6 Backlight Characteristics

LED Backlight

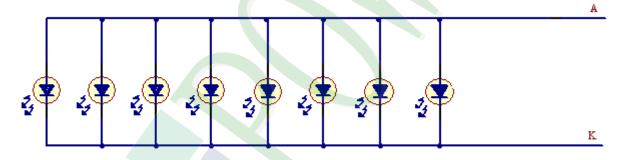
Maximum Ratings

Item	Symbol	Conditions	Min.	Max.	Unit
Forward Current	IF	Ta =25°ℂ	-	240	mA
Reverse Voltage	VR	Ta =25°ℂ	- 🔥	10.4	V
Power Dissipation	PD	Ta =25°ℂ	- ^	1.248	W

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Forward Voltage	VF			5.0	5.2	V
Average Brightness (without LCD)	IV	IF=160 mA	300	370	-	cd/m ²
CIE Color Coordinate	X		0.255	1	0.34	
(Without LCD)	Y		0.265	-	0.35	1
Color			White			

Internal Circuit Diagram:





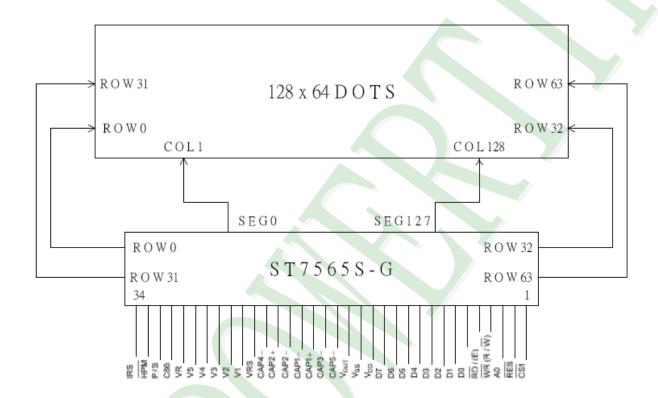
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

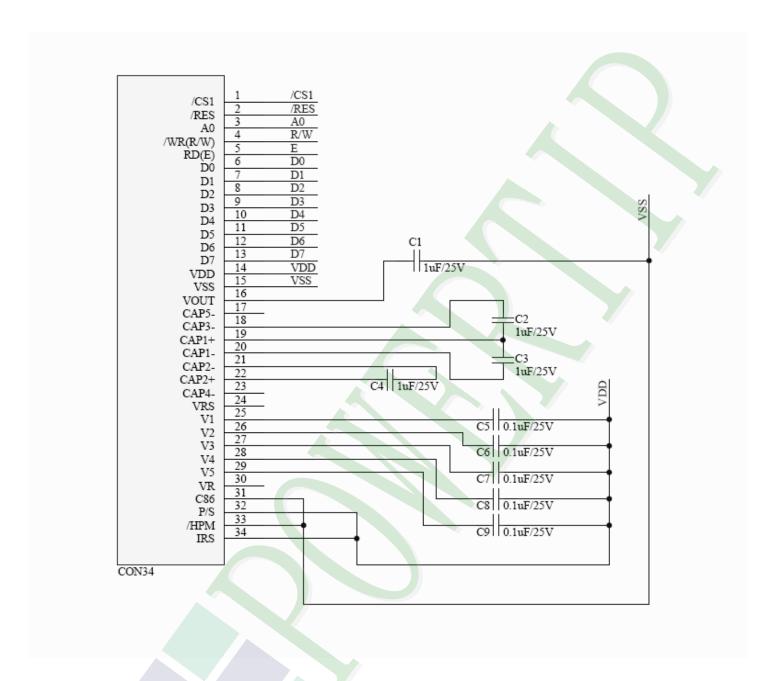
Pin No.	Symbol	Function
	1004	This is the chip select single. When /CS1= L and /CS2 = H then the
1	/CS1	chip select becomes active, and data/command I/O is enabled.
2	/DEC	When /RES is set to L the settings are initialized.
2	/RES	The reset operation is perform by the /RES single level.
		This is connected to the least significant bit of the normal MPU address
3	A0	bus, and it determines whether the data bits are data or a command.
	710	A0 = H : Indicates that D0 to D7 are display data.
		A0 = L : Indicates that D0 to D7 are control data.
		When connected to an 8080 MPU, this is active LOW.
		(R/W) This terminal connects to the 8080 MPU WR single. The
		signals on the data bus are latched at the rising edge of
4	/WR	the WR signal.
'	(R/W)	When connected to a 6800 Series MPU:
		This is the read/write control signal input terminal.
		When R/W = H : Read.
		When R/W = L : Write.
		When connected to an 8080 MPU, this is active LOW.
	/RD	(E) This pin is connected to the RD signal of the 8080 MPU, and the
5	(E)	ST7565S series data bus is in an output status when this signal is L .
	(-/	When connected to an 8080 MPU, this is active HIGH.
		This is the 6800 Series MPU enable clock input terminal.
6	D0	
7	D1	This is an 8-bit bi-directional data bus that connects to an 8-bit or 16 bit
8	D2	standard MPU data bus.
9	D3	When the serial interface is selected (P/S = L):
10	D4	D7 : serial data input (SI) ; D6 : the serial clock input (SCL)
11	D5	D0 to D5 are set to high impedance. When the chip select is not active, D0 to D7 are set to high impedance.
12	D6	their the employees to her detive, be to by die eet to high impedance.
13	D7	
14	VDD	Shared with the MPU power supply terminal VCC.
15	VSS	This is a 0V terminal connected to the system GND.
16	VOUT	DC/DC voltage converter. Connect a capacitor between this terminal and VSS.



Pin No.	Symbol	Function
17	CAP5-	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1+ terminal.
18	CAP3-	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1+ terminal.
19	CAP1+	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1- terminal.
20	CAP1-	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP1+ terminal.
21	CAP2-	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2+ terminal.
22	CAP2+	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2- terminal.
23	CAP4-	DC/DC voltage converter. Connect a capacitor between this terminal and the CAP2+ terminal.
24	VRS	This is the internal-output VREG power supply for the LCD power supply voltage regulator.
25	V1	
26	V2	This is a multi-level power supply for the liquid crystal drive. The voltage
27	V3	Supply applied is determined by the liquid crystal cell, and is changed through the use of a resistive voltage divided or through changing the
28	V4	impedance using an op.amp. Voltage levels are determined based on VDD, and must maintain the relative magnitudes shown below.
29	V5	
30	VR	Output voltage regulator terminal. Provides the voltage between VDD and V5 through a resistive voltage divider. IRS = L : the V5 voltage regulator internal resistors are not used. IRS = H : the V5 voltage regulator internal resistors are used.
31	C86	This is the MPU interface switch terminal. C86 = H : 6800 Series MPU interface. C86 = L : 8080 MPU interface.
32	P/S	This is the parallel data input/serial data input switch terminal. P/S = H : Parallel data input. P/S = L : Serial data input.
33	/HPM	This is the power control terminal for the power supply circuit for liquid crystal drive. HPM = H : Normal mode. HPM = L : High power mode.
34	IRS	This terminal selects the resistors for the V5 voltage level adjustment. IRS = H : Use the internal resistors. IRS = L : Do not use the internal resistors. The V5 voltage level is regulated by external resistive voltage divider attached to the VR terminal



2.2.1 Application Notes:





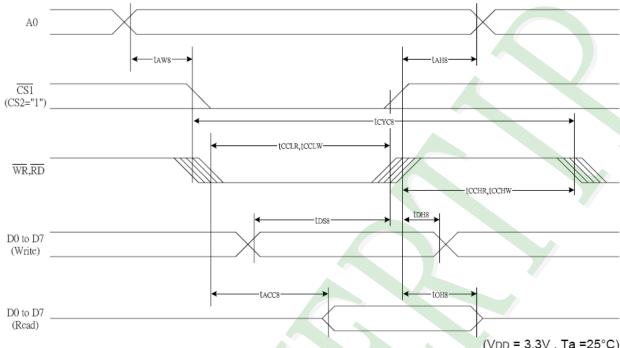
`2.2.2 Refer Initial code:

```
void Initial Main(void)
{
        WriteCOM Main(0xE2);
                                 //Reset Function
        WriteCOM_Main(0x2F);
                                 // Power controller set
        WriteCOM Main(0xA2);
                                 //SET LCD BIAS=1/9 ,BS=0=1/9 BS=1=1/7
        WriteCOM Main(0x26);
                                 //V5 voltage regulator internal resistor ratio set
                                // SET 6.0
        WriteCOM Main(0x81);
                                 //SET REFERENCE VOLTAGE
        WriteCOM Main(0x24);
                                             (1+ra/rb)*(1-\alpha/162)VREG=9.8V
                                 // 24=36
        WriteCOM_Main(0xC0);
                                 //Commom output mode
        WriteCOM Main(0xA1);
                                 // ADC Select 0xa1
        WriteCOM Main(0xA6);
                                 //Display normal
        WriteCOM Main(0x40);
                                 //Display start line
        WriteCOM Main(0xF8);
                                 //Booster set
        WriteCOM Main(0x00);
                                 // 0:4X 1:5X
        WriteCOM_Main(0xA4);
                                 // Display All Points ON/OFF
                                // 0:Normal display mode
                                // 1:Display all points ON
//-----Display On-
        WriteCOM_Main(0xAF);
```



2.3 Timing Characteristics

System Bus Read/Write Characteristics 1 (For the 8080 Series MPU)



				_	3∨ , Ia =25	, ()
Item	Signal	Symbol Condition		Rating		Units
item	Olgilai	Symbol	Condition	Min.	Max.	Units
Address hold time		t _{АН8}		0	_	
Address setup time	A0	t _{AW8}		0	_	
System cycle time		tcyc8		240	_	
Enable L pulse width (WRITE)	WR	tcclw		80	_	
Enable H pulse width (WRITE)	VVIX	t cchw		80	_	
Enable L pulse width (READ)	RD	tcclr		140	_	Ns
Enable H pulse width (READ)	, KD	tcchr		80		
WRITE Data setup time		t _{DS8}		40	_	
WRITE Address hold time	D0 to D7	t _{DH8}		10	_]
READ access time	DU 10 D7	tACC8	CL = 100 pF	_	70]
READ Output disable time		tонв	CL = 100 pF	5	50	

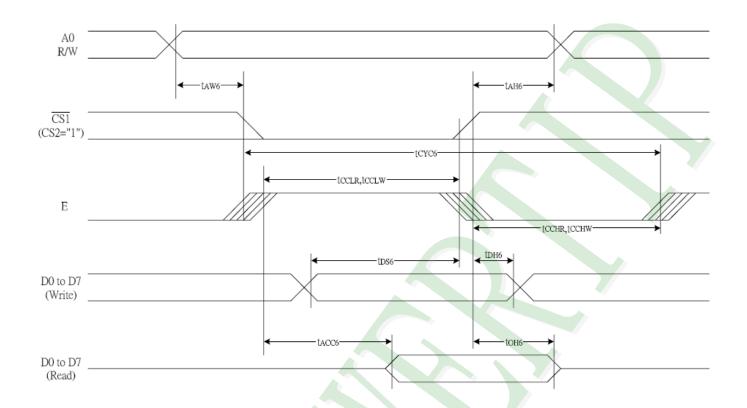
^{*1} The input signal rise time and fall time (tr, tr) is specified at 15 ns or less. When the system cycle time is extremely fast, $(t_r + t_f) \le (t_{CYC8} - t_{CCLW} - t_{CCHW})$ for $(t_r + t_f) \le (t_{CYC8} - t_{CCLR})$ are specified.

^{*2} All timing is specified using 20% and 80% of VDD as the reference.

^{*3} toolw and tools are specified as the overlap between /CS1 being "L" (CS2 = "H") and /WR and /RD being at the "L" level.



System Bus Read/Write Characteristics 2 (For the 6800 Series MPU)



(VDD = 3.3 V , Ta = 25°C

				. \	V , Ta = 25)
Item	Signal	Symbol Condition		Rating		Units
Item	Olgital	Symbol	Condition	Min.	Max.	Units
Address hold time		t AH6		0	_	
Address setup time	A0	taw6		0	_	
System cycle time		tcyc6		240	_	
Enable L pulse width (WRITE)	WR	tewLW		80	_	
Enable H pulse width (WRITE)	VVK	tewnw		80	_]
Enable L pulse width (READ)	RD	tewlr		80	_	ns
Enable H pulse width (READ)	, KD	tewhr		140]
WRITE Data setup time		tos6		40	_]
WRITE Address hold time	D0 to D7	t _{DH6}		10	_	
READ access time	ט נט טי	tacc6	CL = 100 pF	_	70]
READ Output disable time		t он6	CL = 100 pF	5	50	

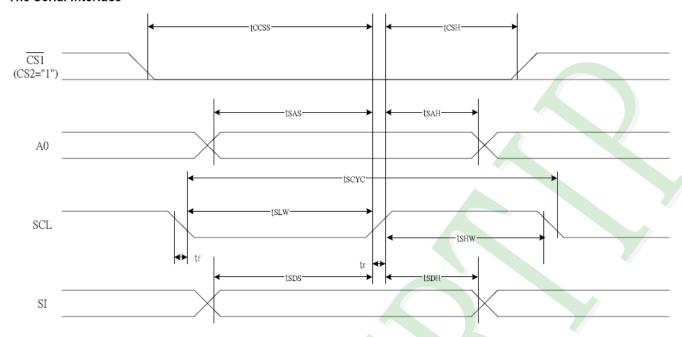
^{*1} The input signal rise time and fall time (t_r, t_f) is specified at 15 ns or less. When the system cycle time is extremely fast, $(t_r + t_f) \le (t_{CYC6} - t_{EWLW} - t_{EWHW})$ for $(t_r + t_f) \le (t_{CYC6} - t_{EWLR} - t_{EWHR})$ are specified.

^{*2} All timing is specified using 20% and 80% of VDD as the reference.

^{*3} tewlw and tewlr are specified as the overlap between CS1 being "L" (CS2 = "H") and E.



The Serial Interface

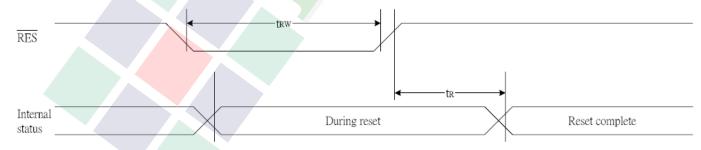


(VDD = 3.3V, Ta =25°C)

Item	Signal Symbol Condition		Condition	Rating		Units
Item	Signal	Symbol	Condition	Min.	Max.	Units
Serial Clock Period		Tscyc		50	_	
SCL "H" pulse width	SCL	Tshw		25	_	
SCL "L" pulse width		Tslw		25	_	
Address setup time	A0	Tsas		20	_	
Address hold time	AU	Tsah		10	_	ns
Data setup time	2	Tsds		20	_	
Data hold time	SI	Tsph		10	_	
CS-SCL time	cs	Tcss		20	_	
CS-SCL time	05	Tcsh		40	_	

- *1 The input signal rise and fall time (tr, tf) are specified at 15 ns or less.
- $^{\ast}2$ All timing is specified using 20% and 80% of VDD as the standard.

Reset Timing

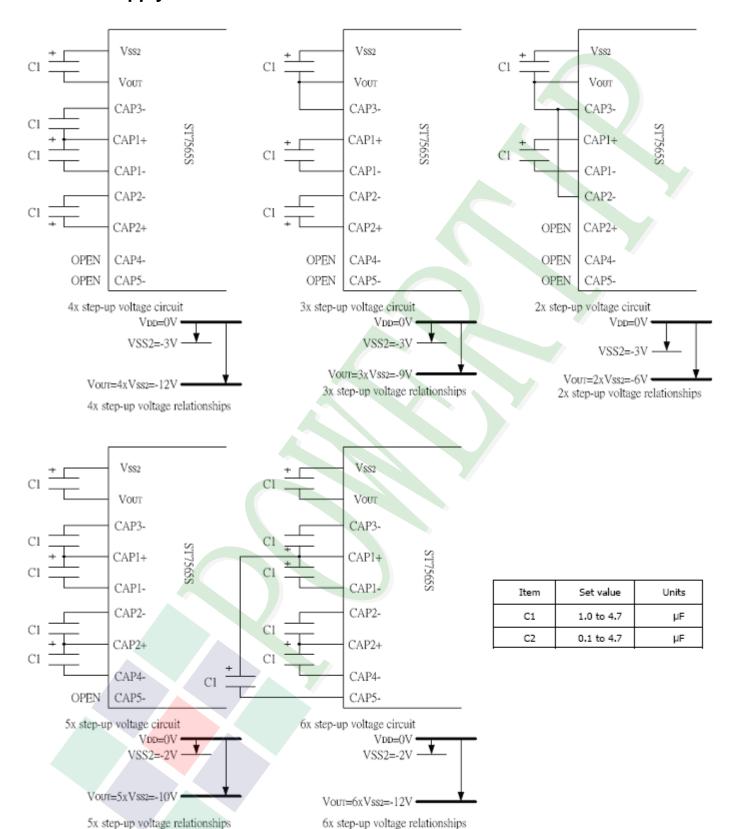


 $(V_{DD} = 3.3V, Ta = -40 \text{ to } 85^{\circ}C)$

Item	Signal	Symbol	Condition	·	Rating		Unito
item	Signal	Syllibol	Condition	Min.	Тур.	Max.	Units
Reset time		t R		_	-	0.5	us
Reset "L" pulse width	/RES	trw		0.5	_	-	us



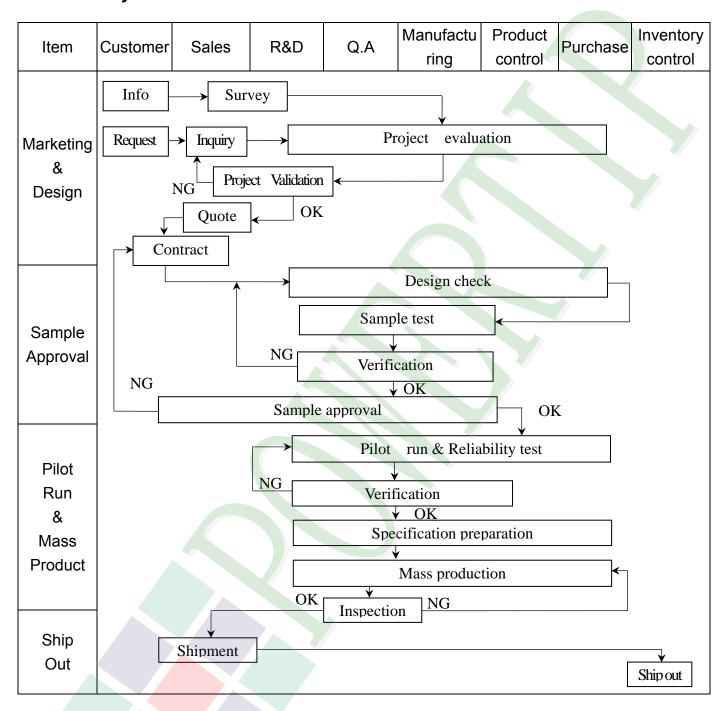
2.4Power supply for LCD module



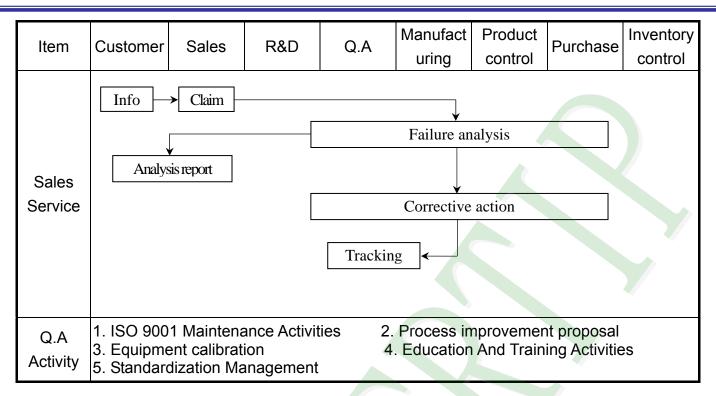


3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart









3.2 Inspection Specification

- ◆Scope: The document shall be applied to LCD Module for Monotype and Color STN(Ver. B01).
- ◆Inspection Standard : MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.
- ◆Equipment : Gauge · MIL-STD · Powertip Tester · Sample
- ◆Defect Level: Major Defect AQL: 0.4; Minor Defect: AQL: 1.5.
- **♦**OUT Going Defect Level : Sampling .
- ◆Manner of appearance test :
 - (1). The test be under 20W×2 fluorescent light 'and distance of view must be at 30 cm.
 - (2). Standard of inspection: (Unit: mm)
 - (3). The test direction is base on about around 45° of vertical line. (Fig. 1)
 - (4). Definition of area . (Fig. 2)

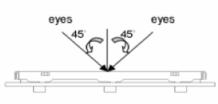


Fig.1

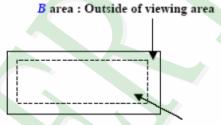


Fig. 2 A area: viewing area

◆ Specification:

NO	Item	Criterion	Level
		1. 1 The part number is inconsistent with work order of Production.	Major
01	Product condition	1. 2 Mixed production types.	Major
		1. 3 Assembled in inverse direction.	Major
02	Quantity	2. 1 The quantity is inconsistent with work order of production.	Major
03	Outline dimension	3. 1 Product dimension and structure must conform to Structure diagram.	Major
		4. 1 Missing line character and icon.	Major
		4. 2 No function or no display.	Major
04	Electrical Testing	4, 3 Output data is error.	Major
		4. 4 LCD viewing angle defect.	Major
		4. 5 Current consumption exceeds product specifications.	Major



NO	Item	C	Criterion			Level	
	Black or white dot \ scratch \ contamination	 5. 1 Round type: 5. 1. 1 display only: • White and black spots on 4 white or black spots pr • Densely spaced: NO more 	esent.				,
	Round type	5. 1. 2 Non-display : Dimension (diameter : Φ)		Acceptance A area	(Q't		2//
		$\Phi \leq 0.10$		ept no dense	В	area	
0.5	$\begin{array}{c c} X & \\\hline Y & \\\hline \end{array}$	$0.10 < \Phi \leq 0.20$		3			3.5.
05	→	$0.20 < \Phi \leq 0.30$		2	J	Ignore	Minor
	$\Phi = (x+y)/2$	Total quantity		4			
		5. 1. 3 Line type: Dimension	Y	Accep	otano	e (Q'ty)	
	Line type	Length (L) Width (W)		A area		B area	
	$\begin{array}{c c} & & \downarrow & W \\ \hline & \downarrow & W \\ \hline & \downarrow & \downarrow & \\ \hline & & \downarrow & \\ \hline & & & \\ \end{array}$	L \leq 3. 0 0. 03 < W \leq 0 L \leq 2. 5 0. 05 < W \leq 0	0. 05	Accept no de	nse	Ignore	
		W >0	. 075	As	roun	d type	
		Dimension		Acceptan	ce (Q		
		(diameter : Φ)		A area		B area	
	Polarizer	$\Phi \le 0.20$ $0.20 < \Phi \le 0.50$	Ac	ccept no dense			
06	Bubble	$0.50 < \Phi \le 1.00$		2		Ignore	Minor
		Φ > 1.00		0			
		Total quantity		4			
			I .				



NO	Item	Criterion	Level
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of crack W: terminal length a: LCD side length	
		7.1 General glass chip: 7.1.1 Chip on panel surface and crack between panels:	
07	The crack of glass	SP SP [NG]	Minor
		X Y Z	
		≤ a Crack can't enter viewing area ≤1/2 t	
		≤ a Crack can't exceed the half of SP width. 1/2 t < Z ≤2 t	



NO	Item	Criterion	Level
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 7. 1. 2 Corner crack:	
		X Y Z	
		≤1/5 a Crack can't enter viewing area Z ≤ 1/2 t	
07	The crack of		3.5
01	glass	7.2 Protrusion over terminal:	Minor
		7. 2. 1 Chip on electrode pad:	
		X Y Z X Y Z	
		X	
	X	X Y Z	
		Front \leq a \leq 1/2 W \leq t	
		Back Neglect	



NO	Item	Criterion	Level
		Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass X: The width of crack W: terminal length a: LCD side length	
		7.2.2 Non-conductive portion:	
07	The crack of glass	X Y Z ≤1/3 a ≤W ≤t O If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode	Minor
		terminal specifications. 7. 2. 3 Glass remain: X Y	



NO	Item	Criterion	Level
08		8. 1 Backlight can't work normally.	Major
	Backlight elements	8. 2 Backlight doesn't light or color is wrong.	Major
		8. 3 Illumination source flickers when lit.	Major
	General	9. 1 Pin type must match type in specification sheet.	Major
		9. 2 No short circuits in components on PCB or FPC.	Major
09		9. 3 Product packaging must the same as specified on packaging specification sheet.	Minor
		9. 4 The folding and peeled off in polarizer are not acceptable.	Minor
		9. 5 The PCB or FPC between B/L assembled distance (PCB or FPC) is ≤1.5 mm.	Minor



4. RELIABILITY TEST

4.1 Reliability Test Condition

NO.	TEST ITEM	TEST CONDITION			
1	High Temperature Storage Test	Keep in 80 ±2℃ 96 hrs Surrounding temperature, then storage at normal condition 4hrs.			
2	Low Temperature Storage Test	Keep in -30 ±2°C 96 hrs Surrounding temperature, ther 4hrs.	storage at normal condition		
3	High Temperature / High Humidity Storage Test	4hrs. (Excluding the polarizer)	en storage at normal condition		
4	Temperature Cycling Storage Test	-30°C→ +25°C → 80°C → +25°C (30mins) (5mins) (30mins) (5mins) 10 Cycle Surrounding temperature, then storage at normal condition 4hrs.			
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance : 15°C ~35°C 2. Humidity relative : 30%~60% 3. Energy Storage Capacitance(Cs+Cd) : 150pF±10% 4. Discharge Resistance(Rd) : 330 Ω±10% 5. Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication : ±5%)			
6	Vibration Test (Packaged)	 Sine wave 10~55 Hz frequency (1 min/sweep) The amplitude of vibration :1.5 mm Each direction (X ⋅ Y ⋅ Z) duration for 2 Hrs 			
7	Drop Test (Packaged)	Packing Weight (Kg 0 ~ 45.4 45.4 ~ 90.8 90.8 ~ 454 Over 454 Drop Direction : %1 corner / 3 e	122 76 61 46		



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is 320±10°C and 3-5 sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ±5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

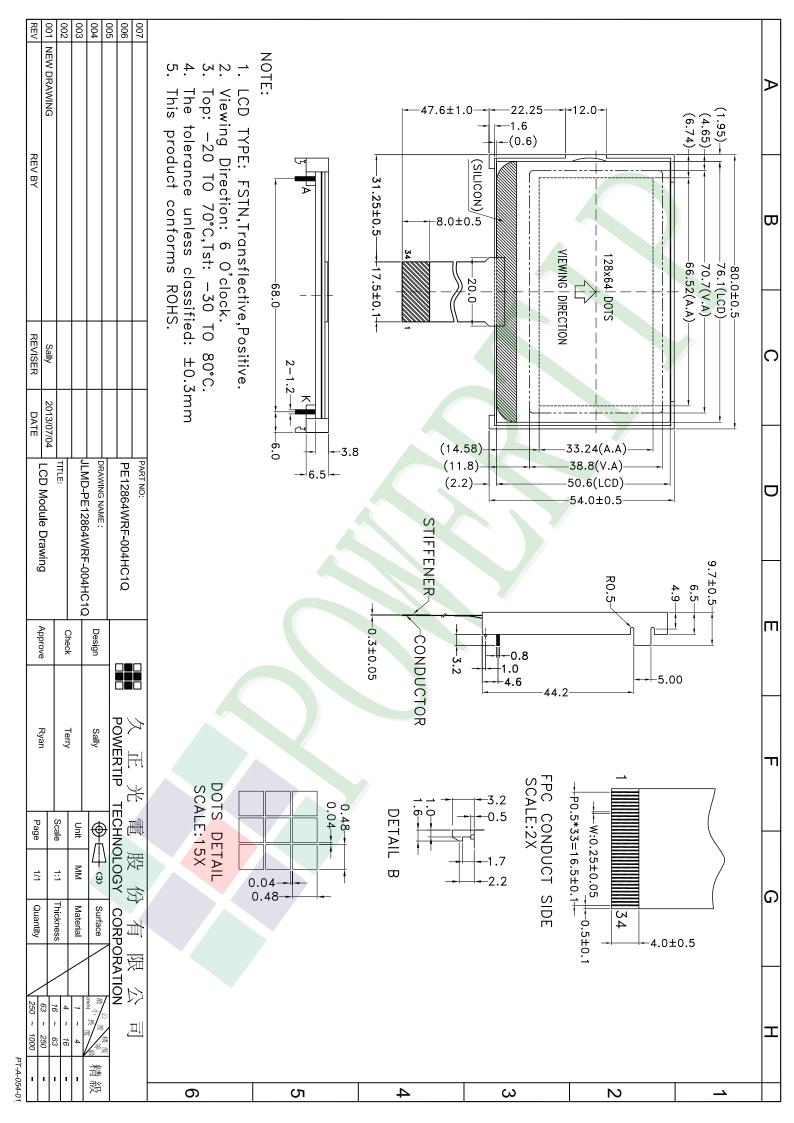
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Check Approve Contact LCM包裝規格書 Ver.001 LCM Packaging Specifications Documents NO. JPKG-PE12864WRF-004HC1Q Ryan Terry Sally (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) No. Item Model Dimensions (mm) 1Pcs Weight Quantity Total Weight PE12864WRF-004HC1Q 1 成品 (LCM) 80.0 X 54.0 144 0.025 3.6 2 多層薄膜(1)POF 19"X350X0.015 6 OTFILM0BA03ABA 3 295 X 245 X 18.8 32 TRAY 盤 (2)Tray TY12806404TZBA 0.08 2.56 4 內盒(3)Product Box BX31025580AABA 310 X255 X 86 8 1.6 0.2 5 海綿墊(4)Foam Rubber Cushion OTFOAM00006ABA 290 X 240 X 10 0.02 16 0.32 6 外紙箱(5)Carton 527 X 325 X 360 BX52732536CCBA 0.83 0.83 7 8 9 Kg±10% 2. 一整箱總重量 (Total LCD Weight in carton): 3. 單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity per box : no per tray x no of tray 6 18 (2)Total LCM quantity in carton: quantity per box x no of boxes 18 144 Use empty tray 空盤 (4)海綿墊 Foam Rubber Cushion (1)多層薄膜 POF Put products into the tray (2)TRAY 盤 Tray (4)海綿墊 Foam Rubber Cushion (5)外紙箱 Carton Tray stacking (3)內盒 Product Box 特 記 事 項 (REMARK) 1. Label Specifications: 斜角 Detail B 參照"成品包裝點檢作業標準書"內容 圓角 Tray 1 2.TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.